

SOT1761-1

plastic, small outline; leaded package; 16 terminals; 1.27 mm pitch; 10.3 mm x 7.5 mm x 3.43 mm body

15 December 2016

Package information

1. Package summary

Terminal position code D (double)

Package type descriptive code SO
Package type industry code SO16

Package style descriptive code SO (small outline)

Package body material type P (plastic)

Mounting method type S (surface mount)

Issue date25-5-2016Manufacturer package code98ASB16926C

Table 1. Package summary

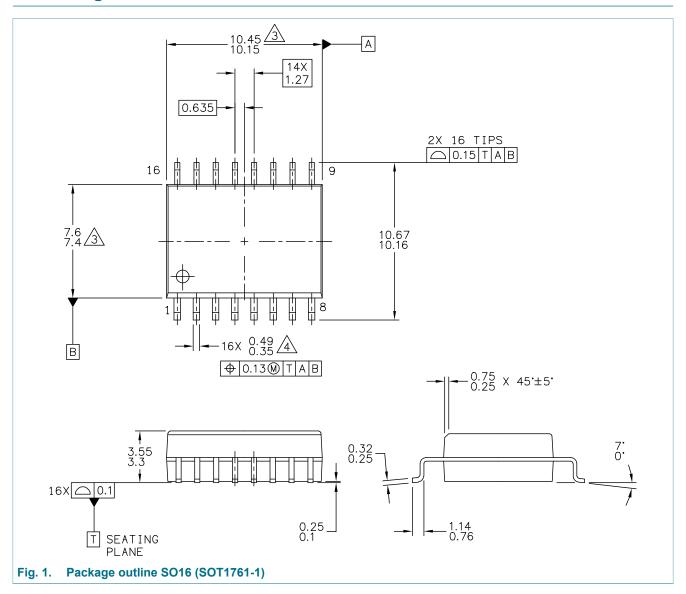
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	10.15	-	10.3	10.45	mm
E	package width	7.4	-	7.5	7.6	mm
Α	seated height	3.3	-	3.43	3.55	mm
е	nominal pitch	-	-	1.27	-	mm
n ₂	actual quantity of termination	-	-	16	-	



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2. Package outline



NOTES:

- 1. ALL DIMENSONS ARE IN MILLIMETERS.
- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
- THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 PER SIDE.
- THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
 PROTRUSIONS SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.75

Fig. 2. Package outline note SO16 (SOT1761-1)

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3. Legal information

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